

HEADERS & RECEPTACLES







PRODUCT DRAWING



♣ 3D PDF

TE CONNECTIVITY (TE)

03 MTE HDR SRST LATCH W/HLDWN

AMPMODU | AMPMODU MTE

5-103908-2

TE Internal Number: 5-103908-2

Always EU RoHS/ELV Compliant

Centerline 2.54 mm [.1 in]

Number of Positions 3

PCB Mounting Orientation Vertical

PCB Mounting Style Through Hole

Number of Rows 1

Product Drawings

HEADER ASSY, AMPMODU MTE, VERTICAL, SINGLE ROW, .100 CL, .025 SQ

POSTS WITH LATCH & RETENTIVE POSTS

PDF English

CAD Files

Customer View Model

2D_DXF.ZIP English

3D PDF

Customer View Model

3D_IGS.ZIP English

Customer View Model

3D_STP.ZIP English

Catalog Pages/Data Sheets

AMPMODU_INTERCONNECTION_SYSTEM_SECTION5_CONT

PDF **English**

AMP MODU MTE Section Of Catalog 1307819

PDF **English**

AMPMODU MTE INTERCONNECT SYSTEM

PDF **English**

Product Specifications

Application Specification AMPMODU MTE Interconnection System

PDF **English**

Product Environmental Compliance

TE Material Declaration

MD_5-103908-2_07012015727_dmtec

PDF ...

Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

Product Type Features PCB Mounting Orientation Vertical Product Type Connector Connector Type Header Strain Relief Without Row-to-Row Spacing 2.54 mm [.1 in] Connector Style Plug PCB Orientation Feature No Applies To Printed Circuit Board Configuration Features Number of Positions 3 Number of Rows 1 Backwall/Post Interruptions Without Electrical Characteristics Dielectric Withstanding Voltage 600 V Insulation Resistance 5000 MΩ Termination Resistance 5000 MΩ Body Features Header Type Shrouded Contact Features Contact Mating Area Plating Material Gold Contact Mating Area Plating Thickness (μin) 30 Contact Termination Area Plating Thickness 2.54 – 5.08 μm [100 – 200 μin] Contact Shape Square	
Connector Type Header Strain Relief Without Row-to-Row Spacing 2.54 mm [.1 in] Connector Style Plug PCB Orientation Feature No Applies To Printed Circuit Board Configuration Features Number of Positions 3 Number of Rows 1 Backwall/Post Interruptions Without Electrical Characteristics Dielectric Withstanding Voltage 600 V Insulation Resistance 5000 MΩ Termination Resistance 5000 MΩ Body Features Header Type Shrouded Contact Features Contact Mating Area Plating Material Gold Contact Mating Area Plating Thickness (μin) 30 Contact Termination Area Plating Thickness (μin) 2.54 - 5.08 μm [100 - 200 μin]	
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Contact Mating Area Plating Thickness (μin) Contact Termination Area Plating Thickness 2.54 – 5.08 μm [100 – 200 μin]	
Contact Termination Area Plating Thickness 2.54 – 5.08 μm [100 – 200 μin]	
Contact Shape Square	
Contact Termination Area Plating Material Tin	
Tail Plating Material Tin	
Tail Plating Thickness 2.54 – 5.08 μm [100 – 200 μin]	
Contact Type Pin	
Solder Tail Contact Plating Material Tin	
Contact Current Rating (A) 3	
Contact Termination Area Plating Material Matte Finish	
Contact Base Material Brass	

Termination Features	Termination Method to Wire/Cable	Crimp, Insulation Displacement Crimp (IDC)
Mechanical Attachment	PCB Mounting Style	Through Hole
	PCB Mount Alignment	Without
	Mating Retention	With
	PCB Mount Retention	With
	PCB Mount Retention Type	Hold-Down
	Contact Retention	With
	Mating Alignment Type	Latched
	Contact Retention Type	Locking Lance
	Mating Retention Type	Hold-Down
	Mating Alignment	With
Housing Features	Centerline	2.54 mm [.1 in]
	Housing Color	Black
	Housing Material	Thermoplastic
Dimensions	Tail Length	3.3 mm [.13 in]
	Mating Post Length	5.84 mm [.23 in]
	PCB Thickness (Recommended)	.69 mm [.027 – .08 in]
	Height	13.59 mm [.535 in]
	Length	10.16 mm [.4 in]
Usage Conditions	Operating Temperature Range (°C)	-65 – 105
Operation/Application	For Use With	Receptacle Housing Assembly
	Pick and Place Cover	Without
Industry Standards	UL Flammability Rating	UL 94V-0
	Approved Standards	CSA LR7189, UL E28476
Packaging Features	Packaging Method	Tube, Tube/Box
	Packaging Quantity	52
Other	Comment	Use Keying Tool No. 91417-1 to remove post for keying.

CUSTOMERS ALSO BOUGHT



